## Influence of Backscattering on the Spatial Resolution of Semiconductor X-ray Detectors

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Siemens medical Solutions that help 6th International Workshop on Radiation Imaging Detectors Glasgow, Scotland, UK, 2004

### Outline

### Introduction

- ♦ What limits spatial resolution?
- Simulations with and without backscattering objects
- Results
- Summary and conclusions

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### Introduction

#### Medical X-ray detectors

- Note: Section 2018 Note: Section
- ℵ <u>Future</u>: semiconductor-based flat-panel detector

#### Registration concepts

- ℵ Scintillator + matrix of photodiodes and switches
- ℵ Directly absorbing semiconductor + matrix of switches
- Signal integration or counting of X-ray quanta

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#### Spatial resolution required

- Soft tissue: 0 ... 2 lp/mm (line pairs per mm)
- ℵ Bones: 0 ... > 3 lp/mm
- ℵ Dental, mammography: 0 ... > 5 lp/mm ... 10 lp/mm ... 20 lp/mm

### What limits spatial resolution?

#### Ð X-ray interaction with absorber

- 🖏 Elastic (Rayleigh) scattering
- Inelastic (Compton) scattering generating fast electrons Å
- Photoelectric absorption generating fluorescent guanta and fast electrons
- £) Electron energy loss
  - ▲ Elastic scattering
  - Multiple excitation of electron-hole pairs



### What else limits spatial resolution?

Transport (for directly absorbing detectors)

- ℵ Charge carriers are collected by drift
- ℵ Charge carriers are spread by diffusion





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Integration and sampling

- Signal is integrated over pixel area
- Ambiguity by sampling for spatial frequencies > Nyquist frequency

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### Simulations

- Monte Carlo simulation
  - Program, ROSI (<u>Ro</u>entgen <u>Si</u>mulation), based on EGS4 algorithm
  - ℵ Mono-energetic range 20 keV … 120 keV
  - 🖏 Common spectra 28 kV ... 120 kV

#### X-ray fan beam hits a pixelated detector grid

Slightly (5°) tilted to produce oversampling

#### Line spread function

Used to calculate the modulation transfer function (MTF)



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## Setup (1)

- Materials and detectors investigated
  - 🖏 300 μm and 700 μm Si on Medipix-2 (55 μm pixels)
  - 🖏 300 μm GaAs on Medipix-2 (55 μm pixels)
- Setup
  - Absorbing semiconductor layer 300/700 μm Si (300 μm GaAs)
  - Bump-bond level
    1.8 µm In layer
    (bumps 21.8 µm in diameter)
  - Medipix-2 chip 500 µm Si
  - Printed circuit board1 mm PMMA

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### Setup (2)

- Materials and detectors investigated
  - 200 μm Se on a-Si readout matrix (70 μm pixels)
  - 420 μm Csl on a-Si readout matrix (143 μm pixels)
- Setup
  - Absorbing layer
    200 μm Se (420 μm Csl)
  - Glass substrate3 mm Corning 7059
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### Results (1)

- 20 keV ... 120 keV
- δ 300 µm Si with Medipix-2 and chip board
- ♦ Low-frequency drop visible for  $E > E_{K}(In) = 27.94 \text{ keV}$



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### Results (2)

- $\clubsuit$  300 / 700  $\mu m$  Si with Medipix-2 and chip board at 50 keV
- Si without backscattering objects behind the absorber
- In bumps or homogeneous layer





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### **Results (3)**

- & 300 / 700  $\mu m$  Si with Medipix-2 and chip board at 120 keV
- Backscattered quanta from chip and chipboard are partly absorbed by the In layer, but penetrate the gaps between the bumps

The thinner Si leads to a stronger backscatter effect



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### **Results (4)**

- 200 µm Se layer with a-Si readout matrix on glass substrate (3 mm Corning 7059) and additional 1 mm Pb shielding
- Low-frequency drop caused by backscatter (compare to inset)



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### Results (5)

 420 µm CsI layer with a-Si readout matrix on glass substrate (3 mm Corning 7059) and additional 1 mm Pb shielding (optical effects on MTF not taken into account)

Low backscattering has low effect on MTF (compare to inset)



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### **Scatter fraction**

Scatter fraction rises above K-edge of backscattering object
 Notice Number Strate for Medipix-2, i.e. E > E<sub>K</sub>(In) = 27.94 keV
 Scatter for CsI and Se detectors, i.e. E > E<sub>K</sub>(Ba) = 37.44 keV



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### Summary

- ♦ Upper limit for MTF is the sinc function of the pixel size
  - At energies below K-edge, the MTF is close to the sinc function
  - At energies above K-edge, fluorescence spreads the signal, thus reducing resolution
  - ℵ Above 50 keV, resolution is reduced by the range of fast electrons
  - Carrier transport has an influence on MTF
- Transmitted and backscattered quanta reach the whole detector
  - $\mathbb{X}$  MTF is reduced at low spatial frequency  $\rightarrow$  low-frequency drop
  - Effect increases above K-edge of backscattering object
- Monochromatic quanta and common X-ray spectra lead to comparable results

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### Conclusions

- The effect of backscatter on spatial resolution must not be ignored
  - Important with thin absorbers, where a high fraction of incident quanta is transmitted
  - ➡ Dependent on materials behind absorber (substrate, chips)
- Interpretation of charge sharing may be wrong due to backscattered quanta
  - ℵ Can be tested by experiments below/above K-edge

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